

## Description

The 9DMV0141B is a 1.8V member of IDT's full-featured PCIe family. The 9DMV0141B has integrated output terminations for direct connection to 100Ω transmission lines. The output has an OE# pin for optimal system control and power management. The parts provide asynchronous or glitch-free switching modes.

## PCIe Clocking Architectures Supported

- Common Clocked (CC)
- Independent Reference (IR) with and without spread spectrum

## Typical Applications

- Servers
- nVME drives
- Embedded systems/Industrial control
- High-performance computing
- Accelerators

## Key Specifications

- Additive cycle-to-cycle jitter < 5ps
- Additive PCIe Gen4 phase jitter < 50fs rms
- 156.25MHz additive phase jitter 130fs rms typical (12kHz to 20MHz)

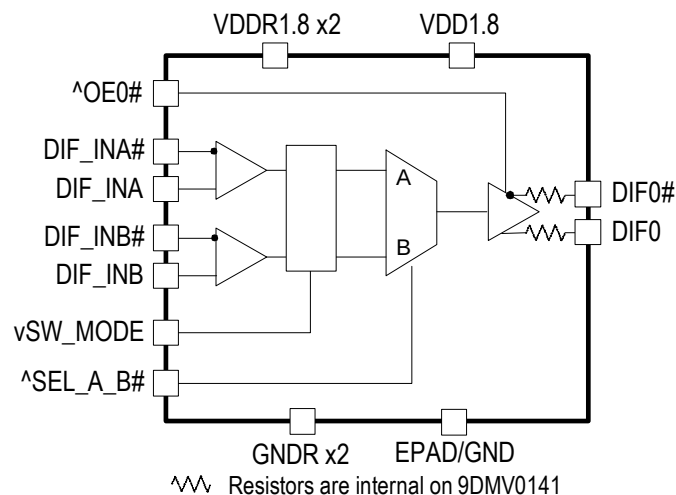
## Features

- Direct connection to loads saves 4 resistors compared to standard PCIe devices
- 1.8V operation; 12mW typical power consumption
- Selectable asynchronous or glitch-free switching; allows the mux to be selected at power up even if both inputs are not running, then transition to glitch-free switching mode
- OE# pin for flexible power sequencing
- HCSL differential inputs
- Spread spectrum tolerant; allows reduction of EMI
- 1MHz to 200MHz operating frequency
- Configuration accomplished with strapping pins, no SMBus needed
- Space-saving 3 × 3 mm 16-VFQFPN; minimal board space

## Output Features

- 1 Low-Power HCSL (LP-HCSL) DIF pair

## Block Diagram

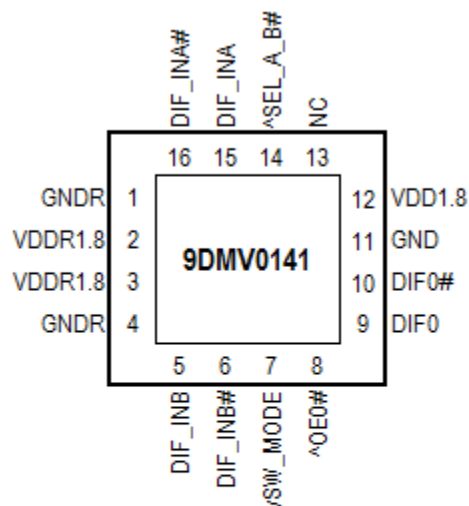


# Contents

|                                                 |    |
|-------------------------------------------------|----|
| Description . . . . .                           | 1  |
| PCIe Clocking Architectures Supported . . . . . | 1  |
| Typical Applications . . . . .                  | 1  |
| Key Specifications . . . . .                    | 1  |
| Features . . . . .                              | 1  |
| Output Features . . . . .                       | 1  |
| Block Diagram . . . . .                         | 1  |
| Pin Assignments . . . . .                       | 3  |
| Pin Descriptions . . . . .                      | 3  |
| Absolute Maximum Ratings . . . . .              | 5  |
| Thermal Characteristics . . . . .               | 5  |
| Electrical Characteristics . . . . .            | 6  |
| Test Loads . . . . .                            | 10 |
| Alternate Terminations . . . . .                | 10 |
| Package Outline Drawings . . . . .              | 10 |
| Marking Diagram . . . . .                       | 10 |
| Ordering Information . . . . .                  | 11 |
| Revision History . . . . .                      | 11 |

## Pin Assignments

**Figure 1. Pin Assignments for 3 × 3 mm 16-VFQFPN Package – Top View**



### 16-VFQFPN, 3 x 3 mm, 0.5mm pitch

^ prefix indicates internal 120kOhm pull-up resistor

v prefix indicates internal 120kOhm pull-down resistor

Note: Paddle may be connected to ground for thermal purposes. It is not required electrically.

## Pin Descriptions

**Table 1. Pin Descriptions**

| Number | Name     | Type   | Description                                                                                                                                                                                                                                                                                                      |
|--------|----------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1      | GNDR     | GND    | Analog ground pin for the differential input (receiver).                                                                                                                                                                                                                                                         |
| 2      | VDDR1.8  | Power  | Power supply for differential input clock (receiver). This $V_{DD}$ should be treated as an analog power rail and filtered appropriately. Nominally 1.8V.                                                                                                                                                        |
| 3      | VDDR1.8  | Power  | Power supply for differential input clock (receiver). This $V_{DD}$ should be treated as an analog power rail and filtered appropriately. Nominally 1.8V.                                                                                                                                                        |
| 4      | GNDR     | GND    | Analog ground pin for the differential input (receiver).                                                                                                                                                                                                                                                         |
| 5      | DIF_INB  | Input  | True input of differential clock.                                                                                                                                                                                                                                                                                |
| 6      | DIF_INB# | Input  | Complement input of differential clock.                                                                                                                                                                                                                                                                          |
| 7      | vSW_MODE | Input  | Switch Mode. This pin selects either asynchronous or glitch-free switching of the mux. Use asynchronous mode if 0 or 1 of the input clocks is running. Use glitch-free mode if both input clocks are running. This pin has an internal pull down resistor of ~s.<br>0 = asynchronous mode, 1 = glitch-free mode. |
| 8      | ^OE0#    | Input  | Active low input for enabling output 0. This pin has an internal pull-up resistor.<br>1 = disable output, 0 = enable output.                                                                                                                                                                                     |
| 9      | DIF0     | Output | Differential true clock output.                                                                                                                                                                                                                                                                                  |
| 10     | DIF0#    | Output | Differential complementary clock output.                                                                                                                                                                                                                                                                         |
| 11     | GND      | GND    | Ground pin.                                                                                                                                                                                                                                                                                                      |

**Table 1. Pin Descriptions (Cont.)**

| Number | Name      | Type  | Description                                                                                                                                                           |
|--------|-----------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 12     | VDD1.8    | Power | Power supply, nominally 1.8V.                                                                                                                                         |
| 13     | NC        | —     | No connection.                                                                                                                                                        |
| 14     | ^SEL_A_B# | Input | Input to select differential input clock A or differential input clock B. This input has an internal pull-up resistor.<br>0 = Input B selected, 1 = Input A selected. |
| 15     | DIF_INA   | Input | True input of differential clock.                                                                                                                                     |
| 16     | DIF_INA#  | Input | Complement input of differential clock.                                                                                                                               |

**Table 2. Power Management**

| OEx# Pin | DIF_IN  | DIFx     |                   |
|----------|---------|----------|-------------------|
|          |         | True O/P | Complementary O/P |
| 0        | Running | Running  | Running           |
| 1        | Running | Low      | Low               |

**Table 3. Power Connections**

| Pin Number      |     | Description              |
|-----------------|-----|--------------------------|
| V <sub>DD</sub> | GND |                          |
| 2               | 1   | Input A receiver analog. |
| 3               | 4   | Input B receiver analog. |
| 12              | 11  | DIF outputs,             |

## Absolute Maximum Ratings

The absolute maximum ratings are stress ratings only. Stresses greater than those listed below can cause permanent damage to the device. Functional operation of the 9DMV0141B at absolute maximum ratings is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

**Table 4. Absolute Maximum Ratings**

| Symbol    | Parameter            | Conditions                    | Minimum | Typical | Maximum         | Units | Notes |
|-----------|----------------------|-------------------------------|---------|---------|-----------------|-------|-------|
| $V_{DDx}$ | Supply Voltage       | Applies to all $V_{DD}$ pins. | -0.5    |         | 2.5             | V     | 1,2   |
| $V_{IN}$  | Input Voltage        |                               | -0.5    |         | $V_{DD} + 0.5V$ | V     | 1,3   |
| $T_s$     | Storage Temperature  |                               | -65     |         | 150             | °C    | 1     |
| $T_j$     | Junction Temperature |                               |         |         | 125             | °C    | 1     |
| ESD prot  | Input ESD protection | Human Body Model.             | 2000    |         |                 | V     | 1     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>3</sup> Not to exceed 2.5V.

## Thermal Characteristics

**Table 5. Thermal Characteristics**

| Symbol         | Parameter          | Conditions                      | Package | Value | Units | Notes |
|----------------|--------------------|---------------------------------|---------|-------|-------|-------|
| $\theta_{JC}$  | Thermal Resistance | Junction to case.               | NLG16   | 66    | °C/W  | 1     |
| $\theta_{JB}$  |                    | Junction to board.              |         | 5     | °C/W  | 1     |
| $\theta_{JA0}$ |                    | Junction to air, still air.     |         | 63    | °C/W  | 1     |
| $\theta_{JA1}$ |                    | Junction to air, 1m/s air flow. |         | 56    | °C/W  | 1     |
| $\theta_{JA2}$ |                    | Junction to air, 3m/s air flow. |         | 51    | °C/W  | 1     |
| $\theta_{JA3}$ |                    | Junction to air, 5m/s air flow. |         | 49    | °C/W  | 1     |

<sup>1</sup> EPAD soldered to board.

## Electrical Characteristics

$T_A = T_{AMB}$ , supply voltages per normal operating conditions. See [Test Loads](#) for loading conditions.

**Table 6. Electrical Characteristics–Input/Supply/Common Parameters – Normal Operating Condition**

| Symbol          | Parameter                              | Conditions                                                                                                                                        | Minimum       | Typical | Maximum        | Units  | Notes |
|-----------------|----------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|---------------|---------|----------------|--------|-------|
| $V_{DDxx}$      | Supply Voltage                         | Applies to all $V_{DD}$ pins.                                                                                                                     | 1.7           | 1.8     | 1.9            | V      |       |
| $T_{AMB}$       | Ambient Operating Temperature          | Industrial range.                                                                                                                                 | -40           | 25      | 85             | °C     | 1     |
| $V_{IH}$        | Input High Voltage                     | Single-ended inputs, except SMBus.                                                                                                                | $0.75 V_{DD}$ |         | $V_{DD} + 0.3$ | V      |       |
| $V_{IL}$        | Input Low Voltage                      | Single-ended inputs, except SMBus.                                                                                                                | -0.3          |         | $0.25 V_{DD}$  | V      |       |
| $I_{IN}$        | Input Current                          | Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = V_{DD}$ .                                                                                         | -5            |         | 5              | μA     |       |
| $I_{INP}$       |                                        | Single-ended inputs.<br>$V_{IN} = 0 V$ ; Inputs with internal pull-up resistors.<br>$V_{IN} = V_{DD}$ ; Inputs with internal pull-down resistors. | -100          |         | 100            | μA     |       |
| $F_{ibyp}$      | Input Frequency                        |                                                                                                                                                   | 1             |         | 200            | MHz    | 2     |
| $L_{pin}$       | Pin Inductance                         |                                                                                                                                                   |               |         | 7              | nH     | 1     |
| $C_{IN}$        | Capacitance                            | Logic Inputs, except DIF_IN.                                                                                                                      | 1.5           |         | 5              | pF     | 1     |
| $C_{INDIF\_IN}$ |                                        | DIF_IN differential clock inputs.                                                                                                                 | 1.5           |         | 2.7            | pF     | 1,4   |
| $C_{OUT}$       |                                        | Output pin capacitance.                                                                                                                           |               |         | 6              | pF     | 1     |
| $T_{STAB}$      | Clk Stabilization                      | From $V_{DD}$ power-up and after input clock stabilization or de-assertion of PD# to 1st clock.                                                   |               |         | 1              | ms     | 1,2   |
| $f_{MODINPCle}$ | Input SS Modulation Frequency PCIe     | Allowable frequency for PCIe applications (triangular modulation).                                                                                | 30            |         | 33             | kHz    |       |
| $f_{MODIN}$     | Input SS Modulation Frequency non-Pcie | Allowable frequency for non-Pcie applications (triangular modulation).                                                                            | 0             |         | 66             | kHz    |       |
| $t_{LATO\#}$    | OE# Latency                            | DIF start after OE# assertion.<br>DIF stop after OE# deassertion.                                                                                 | 1             | 2       | 3              | clocks | 1,3   |
| $t_F$           | Tfall                                  | Fall time of single-ended control inputs.                                                                                                         |               |         | 5              | ns     | 1,2   |
| $t_R$           | Trise                                  | Rise time of single-ended control inputs.                                                                                                         |               |         | 5              | ns     | 1,2   |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Control input must be monotonic from 20% to 80% of input swing.

<sup>3</sup> Time from deassertion until outputs are > 200mV.

<sup>4</sup> DIF\_IN input.

**Table 7. Clock Input Parameters**

| Symbol             | Parameter                        | Conditions                                                     | Minimum | Typical | Maximum | Units         | Notes |
|--------------------|----------------------------------|----------------------------------------------------------------|---------|---------|---------|---------------|-------|
| $V_{\text{CROSS}}$ | Input Crossover Voltage – DIF_IN | Crossover voltage (common mode voltage).                       | 200     |         | 725     |               |       |
| $V_{\text{SWING}}$ | Input Swing–DIF_IN               | Differential value.                                            | 300     |         |         | mV            | 1     |
| $dv/dt$            | Input Slew Rate–DIF_IN           | Measured differentially.                                       | 0.6     |         |         | V/ns          | 1,2   |
| $I_{\text{IN}}$    | Input Leakage Current            | $V_{\text{IN}} = 0.8\text{V}$ , $V_{\text{IN}} = \text{GND}$ . | -5      |         | 5       | $\mu\text{A}$ |       |
| $d_{\text{tin}}$   | Input Duty Cycle                 | Measurement from differential waveform.                        | 45      |         | 55      | %             | 1     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Slew rate measured through  $\pm 75\text{mV}$  window centered around differential zero.

**Table 8. DIF Low-Power HCSL Outputs**

| Symbol                    | Parameter              | Conditions                                                                                            | Minimum | Typical | Maximum | Units | Notes |
|---------------------------|------------------------|-------------------------------------------------------------------------------------------------------|---------|---------|---------|-------|-------|
| $T_{\text{RF}}$           | Slew Rate              | Scope averaging on, 9DMV0141B                                                                         | 2       | 2.9     | 4.0     | V/ns  | 1,2,3 |
| $\Delta T_{\text{RF}}$    | Slew Rate Matching     | Slew rate matching, scope averaging on.                                                               |         | 3       | 20      | %     | 1,4   |
| $V_{\text{HIGH}}$         | Voltage High           | Statistical measurement on single-ended signal using oscilloscope math function (scope averaging on). | 660     | 783     | 850     | mV    |       |
| $V_{\text{LOW}}$          | Voltage Low            |                                                                                                       | -150    | 26      | 150     |       |       |
| $V_{\text{MAX}}$          | Max Voltage            | Measurement on single ended signal using absolute value (scope averaging off).                        |         | 790     | 1150    | mV    |       |
| $V_{\text{MIN}}$          | Min Voltage            |                                                                                                       | -300    | 9       |         |       |       |
| $V_{\text{CROSS\_ABS}}$   | Crossing Voltage (abs) | Scope averaging off.                                                                                  | 250     | 393     | 550     | mV    | 1,5   |
| $\Delta V_{\text{CROSS}}$ | Crossing Voltage (var) | Scope averaging off.                                                                                  |         | 12      | 140     | mV    | 1,6   |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform.

<sup>3</sup> Slew rate is measured through the  $V_{\text{SWING}}$  voltage range centered around differential 0V. This results in a  $\pm 150\text{mV}$  window around differential 0V.

<sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a  $\pm 75\text{mV}$  window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>5</sup>  $V_{\text{CROSS}}$  is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>6</sup> The total variation of all  $V_{\text{CROSS}}$  measurements in any particular system. Note that this is a subset of  $V_{\text{CROSS-MIN/MAX}}$  ( $V_{\text{CROSS}}$  absolute) allowed. The intent is to limit  $V_{\text{CROSS}}$  induced modulation by setting  $\Delta V_{\text{CROSS}}$  to be smaller than  $V_{\text{CROSS}}$  absolute.

**Table 9. Current Consumption**

| Symbol             | Parameter                | Conditions                                           | Minimum | Typical | Maximum | Units | Notes |
|--------------------|--------------------------|------------------------------------------------------|---------|---------|---------|-------|-------|
| $I_{\text{DDOP}}$  | Operating Supply Current | $V_{\text{DD}}$ rails, all outputs active at 100MHz. |         | 7.9     | 12      | mA    |       |
| $I_{\text{DDDIS}}$ | Disable Current          | $V_{\text{DD}}$ rails, all outputs disabled Low/Low. |         | 1.5     | 2.5     | mA    | 2     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Input clock stopped after outputs have parked Low/Low.

**Table 10. Output Duty Cycle, Jitter, Skew and PLL Characteristics**

| Symbol        | Parameter              | Conditions                          | Minimum | Typical | Maximum | Units | Notes |
|---------------|------------------------|-------------------------------------|---------|---------|---------|-------|-------|
| $t_{DCD}$     | Duty Cycle Distortion  | Measured differentially, at 100MHz. | -0.5    | -0.12   | 0.5     | %     | 1,3   |
| $t_{pdBYP}$   | Skew, Input to Output  | $V_T = 50\%$ .                      | 1800    | 2409    | 3000    | ps    | 1     |
| $t_{jcy-cyc}$ | Jitter, Cycle to Cycle | Additive Jitter.                    |         |         | 5       | ps    | 1,2   |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform.

<sup>3</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock.

**Table 11. Filtered Additive Phase Jitter Parameters–PCIe Common Clocked (CC) Architectures**

$T_{AMB}$  = over the specified operating range. Supply Voltages per normal operation conditions. See [Test Loads](#) for loading conditions

| Parameter             | Symbol               | Conditions                                                                                            | Minimum | Typical | Maximum | Specification Limits | Units    | Notes   |
|-----------------------|----------------------|-------------------------------------------------------------------------------------------------------|---------|---------|---------|----------------------|----------|---------|
| Additive Phase Jitter | $t_{jphPCIeG1-CC}$   | PCIe Gen1.                                                                                            |         | 0.69    | 5       | N/A                  | ps (p-p) | 1,2,3,4 |
|                       | $t_{jphPCIeG2-CC}$   | PCIe Gen2 Low Band<br>10kHz < f < 1.5MHz<br>(PLL BW of 5–16MHz or 8–16MHz,<br>CDR = 5MHz).            |         | 0.01    | 0.01    |                      | ps (rms) | 1,2,4,6 |
|                       |                      | PCIe Gen2 High Band<br>1.5MHz < f < Nyquist (50MHz)<br>(PLL BW of 5–16MHz or 8–16MHz,<br>CDR = 5MHz). |         | 0.16    | 0.19    |                      | ps (rms) | 1,2,4,6 |
|                       | $t_{jphPCIeG3/4-CC}$ | PCIe Gen3, Gen4<br>(PLL BW of 2–4MHz or 2–5MHz,<br>CDR = 10MHz).                                      |         | 0.07    | 0.08    |                      | ps (rms) | 1,2,4,6 |

**Table 12. Filtered Phase Jitter Parameters – PCIe Independent Reference (IR) Architectures**

$T_{AMB}$  = over the specified operating range. Supply Voltages per normal operation conditions. See [Test Loads](#) for loading conditions

| Parameter             | Symbol               | Conditions                                    | Minimum | Typical | Maximum | Specification Limits | Units    | Notes   |
|-----------------------|----------------------|-----------------------------------------------|---------|---------|---------|----------------------|----------|---------|
| Additive Phase Jitter | $t_{jphPCIeG2-SRIS}$ | PCIe Gen2<br>(PLL BW of 16MHz, CDR = 5MHz).   |         | 0.15    | 0.19    | N/A                  | ps (rms) | 1,2,4,6 |
|                       | $t_{jphPCIeG3-SRIS}$ | PCIe Gen3<br>(PLL BW of 2–4MHz, CDR = 10MHz). |         | 0.04    | 0.05    |                      | ps (rms) | 1,2,4,6 |

Notes for PCIe Filtered Phase Jitter tables:

<sup>1</sup> Applies to all differential outputs, guaranteed by design and characterization.

<sup>2</sup> Calculated from Clock Jitter Tool, when driven by SMA100B.

<sup>3</sup> Sample size of at least 100K cycles. This figure extrapolates to 108ps pk-pk at 1M cycles for a BER of  $10^{-12}$ .

<sup>4</sup> Additive jitter for RMS values is calculated by solving for b, where  $[b = \sqrt{c^2 - a^2}]$ , "a" is rms input jitter and "c" is rms total jitter.

<sup>5</sup> IR is the new name for Separate Reference Independent Spread (SRIS) and Separate Reference no Spread (SRNS) PCIe clock architectures. According to the PCIe Base Specification Rev4.0 version 1.0, the jitter transfer functions and corresponding jitter limits are not defined for the IR clock architecture. The IR filters from the PCIe Base Specification, Rev 3.1a are used to populate this table. There are no accepted filters or limits for IR clock architectures at PCIe Gen1 or Gen4 data rates at the time of publication.

<sup>6</sup> Measured using SMA100B signal source, or equivalent, and a phase noise analyzer.

**Table 13. Unfiltered Phase Jitter Parameters–12kHz to 20MHz**

T<sub>AMB</sub> = over the specified operating range. Supply Voltages per normal operation conditions. See [Test Loads](#) for loading conditions

| Parameter             | Symbol              | Conditions | Minimum | Typical | Maximum | Industry Limits | Units    | Notes |
|-----------------------|---------------------|------------|---------|---------|---------|-----------------|----------|-------|
| Additive Phase Jitter | $t_{jph12k-20Madd}$ | 156.25MHz. |         | 130     |         | N/A             | fs (rms) | 1,2,3 |

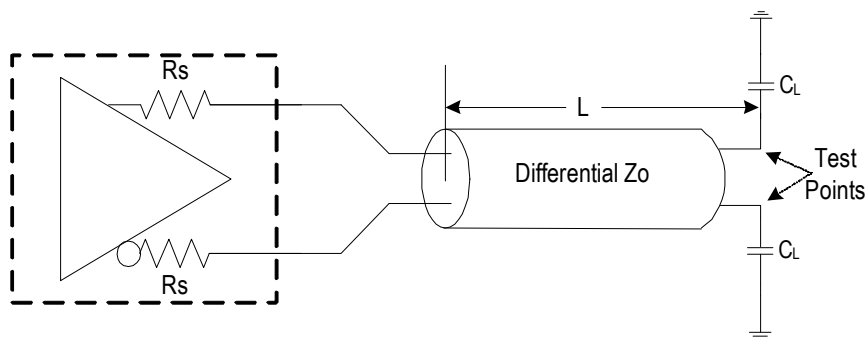
<sup>1</sup> Applies to all differential outputs, guaranteed by design and characterization.

<sup>2</sup> Calculated after applying 12k-20M brickwall filter, when driven by SMA100B source.

<sup>3</sup> Additive jitter for RMS values is calculated by solving for b, where  $[b = \sqrt{c^2 - a^2}]$ , "a" is rms input jitter and "c" is rms total jitter.

## Test Loads

**Figure 2. Low-Power HCSL Output Test Load (standard PCIe source-terminated test load with high impedance receiver)**



**Table 14. Parameters for Low-Power HCSL Output Test Load**

| Device   | $R_s$ ( $\Omega$ ) | $Z_o$ ( $\Omega$ ) | L (inches) | $C_L$ (pF) |
|----------|--------------------|--------------------|------------|------------|
| 9DMV0141 | Internal           | 100                | 5          | 2          |

## Alternate Terminations

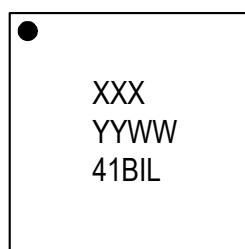
The LP-HCSL output can easily drive other logic families. See [“AN-891 Driving LVPECL, LVDS, and CML Logic with IDT’s “Universal” Low-Power HCSL Outputs”](#) for termination schemes for LVPECL, LVDS, CML, and SSTL.

## Package Outline Drawings

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

[www.idt.com/document/psc/16-vfqfpn-package-outline-drawing-30-x-30-x-09-mm-05-mm-170-x-170-mm-epad-nl16p2](http://www.idt.com/document/psc/16-vfqfpn-package-outline-drawing-30-x-30-x-09-mm-05-mm-170-x-170-mm-epad-nl16p2)

## Marking Diagram



- Line 1: “XXX” is the Asm lot number.
- Line 2 indicates the following:
  - “YY” is the last two digits of the year; “WW” is the work week number when the part was assembled.
- Line 3: truncated part number.

## Ordering Information

| Orderable Part Number | Description                        | Package                   | Carrier Type  | Temperature   |
|-----------------------|------------------------------------|---------------------------|---------------|---------------|
| 9DMV0141BKILF         | Differential $Z_{OUT} = 100\Omega$ | 3 × 3 × 0.9 mm, 16-VFQFPN | Tray          | -40° to +85°C |
| 9DMV0141BKILFT        | Differential $Z_{OUT} = 100\Omega$ | 3 × 3 × 0.9 mm, 16-VFQFPN | Tape and Reel | -40° to +85°C |

## Revision History

| Revision Date     | Description of Change |
|-------------------|-----------------------|
| February 25, 2019 | Initial release.      |



**Corporate Headquarters**  
6024 Silver Creek Valley Road  
San Jose, CA 95138 USA  
[www.IDT.com](http://www.IDT.com)

**Sales**  
1-800-345-7015 or 408-284-8200  
Fax: 408-284-2775  
[www.IDT.com/go/sales](http://www.IDT.com/go/sales)

**Tech Support**  
[www.IDT.com/go/support](http://www.IDT.com/go/support)

DISCLAIMER Integrated Device Technology, Inc. (IDT) and its affiliated companies (herein referred to as "IDT") reserve the right to modify the products and/or specifications described herein at any time, without notice, at IDT's sole discretion. Performance specifications and operating parameters of the described products are determined in an independent state and are not guaranteed to perform the same way when installed in customer products. The information contained herein is provided without representation or warranty of any kind, whether express or implied, including, but not limited to, the suitability of IDT's products for any particular purpose, an implied warranty of merchantability, or non-infringement of the intellectual property rights of others. This document is presented only as a guide and does not convey any license under intellectual property rights of IDT or any third parties.

IDT's products are not intended for use in applications involving extreme environmental conditions or in life support systems or similar devices where the failure or malfunction of an IDT product can be reasonably expected to significantly affect the health or safety of users. Anyone using an IDT product in such a manner does so at their own risk, absent an express, written agreement by IDT.

Integrated Device Technology, IDT and the IDT logo are trademarks or registered trademarks of IDT and its subsidiaries in the United States and other countries. Other trademarks used herein are the property of IDT or their respective third party owners. For datasheet type definitions and a glossary of common terms, visit [www.idt.com/go/glossary](http://www.idt.com/go/glossary). Integrated Device Technology, Inc. All rights reserved.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)

[www.lifeelectronics.ru](http://www.lifeelectronics.ru)